

# F18NM65

**Power MOSFET**

## 18A, 650V N-CHANNEL SUPER-JUNCTION MOSFET

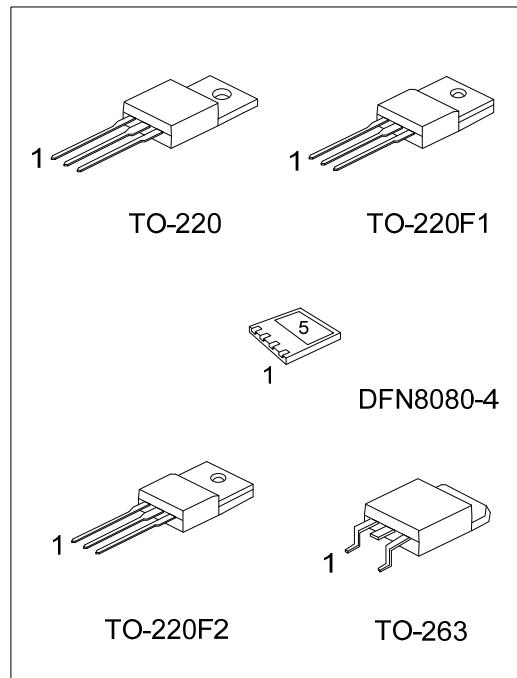
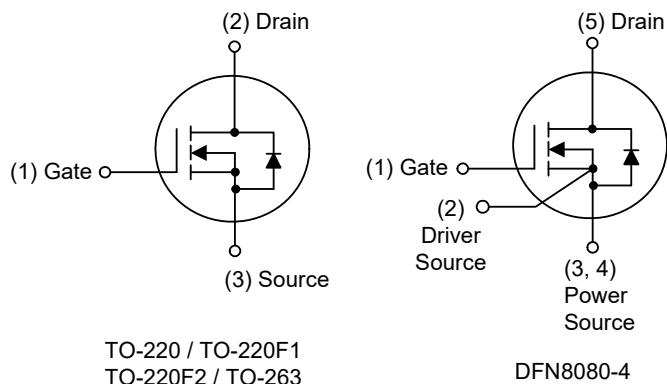
### ■ DESCRIPTION

The UTC **F18NM65** is a N-Channel enhancement mode silicon gate super junction power MOSFET with fast body diode and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

### ■ FEATURES

- \*  $R_{DS(ON)} \leq 0.33 \Omega$  @  $V_{GS} = 10V$ ,  $I_D = 4.5A$
- \* Fast body diode MOSFET technology
- \* High Switching Speed
- \* 100% Avalanche Tested

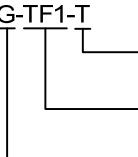
### ■ SYMBOL



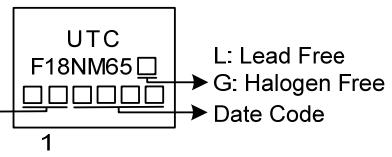
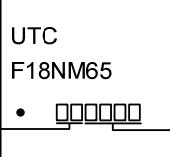
### ■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment					Packing
Lead Free	Halogen Free		1	2	3	4	5	
F18NM65L-TA3-T	F18NM65G-TA3-T	TO-220	G	D	S	-	-	Tube
F18NM65L-TF1-T	F18NM65G-TF1-T	TO-220F1	G	D	S	-	-	Tube
F18NM65L-TF2-T	F18NM65G-TF2-T	TO-220F2	G	D	S	-	-	Tube
F18NM65L-TQ2-T	F18NM65G-TQ2-T	TO-263	G	D	S	-	-	Tube
F18NM65L-TQ2-R	F18NM65G-TQ2-R	TO-263	G	D	S	-	-	Tape Reel
F18NM65L-K04-8080-R	F18NM65G-K04-8080-R	DFN8080-4	G	S	S	S	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

	(1)T: Tube, R:Tape Reel (2)TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2, TQ2: TO-263, K04-8080: DFN8080-4 (3) G: Halogen Free and Lead Free, L: Lead Free
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### ■ MARKING

TO-220 / TO-220F1 / TO-220F2 / TO-263	DFN8080-4
 Lot Code ← 1 → Date Code L: Lead Free G: Halogen Free	 Lot Code ← • → Date Code

■ ABSOLUTE MAXIMUM RATINGS ( $T_c = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	$V_{DSS}$	650	V
Gate-Source Voltage	$V_{GSS}$	$\pm 30$	V
Continuous Drain Current	$I_D$	18	A
Pulsed Drain Current (Note 2)	$I_{DM}$	36	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	252 mJ
Peak Diode Recovery $dv/dt$ (Note 4)	$dv/dt$	12.5 V/ns	
Power Dissipation	TO-220/TO-263	$P_D$	104 W
	TO-220F1/TO-220F2		30 W
	DFN8080-4		62 W
Junction Temperature	$T_J$	+150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3.  $L = 30\text{mH}$ ,  $I_{AS} = 4.18\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 18\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F1	$\theta_{JA}$	62.5 $^\circ\text{C/W}$
	TO-220F2/TO-263		35 (Note) $^\circ\text{C/W}$
Junction to Case	DFN8080-4	$\theta_{JC}$	1.2 $^\circ\text{C/W}$
	TO-220/TO-263		4.16 $^\circ\text{C/W}$
	TO-220F1/TO-220F2		2 (Note) $^\circ\text{C/W}$

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

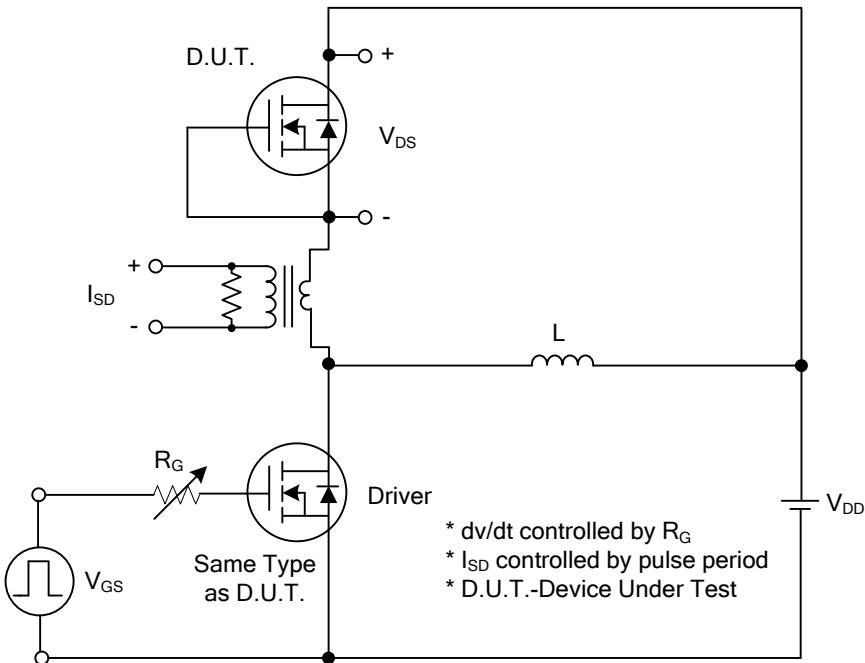
■ ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	650			V
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{\text{DS}}=650\text{V}, V_{\text{GS}}=0\text{V}$		10		$\mu\text{A}$
Gate- Source Leakage Current	Forward	$V_{\text{GS}}=30\text{V}, V_{\text{DS}}=0\text{V}$		100		nA
	Reverse	$V_{\text{GS}}=-30\text{V}, V_{\text{DS}}=0\text{V}$		-100		nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{\text{GS(TH)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.5		4.5	V
Static Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=4.5\text{A}$			0.33	$\Omega$
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$C_{\text{ISS}}$	$V_{\text{DS}}=50\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$		1120		pF
Output Capacitance	$C_{\text{OSS}}$			130		pF
Reverse Transfer Capacitance	$C_{\text{RSS}}$			5.3		pF
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge (Note 1)	$Q_G$	$V_{\text{DS}}=520\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=18\text{A}$ (Note 1, 2)		42		nC
Gate-Source Charge	$Q_{\text{GS}}$			14		nC
Gate-Drain Charge	$Q_{\text{GD}}$			15		nC
Turn-On Delay Time (Note 1)	$t_{\text{D(ON)}}$	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=18\text{A},$ $R_G=25\Omega$ (Note 1, 2)		18		ns
Turn-On Rise Time	$t_R$			26		ns
Turn-Off Delay Time	$t_{\text{D(OFF)}}$			115		ns
Turn-Off Fall Time	$t_F$			74		ns
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
Maximum Continuous Drain-Source Diode Forward Current	$I_S$				18	A
Maximum Pulsed Drain-Source Diode Forward Current	$I_{\text{SM}}$				36	A
Drain-Source Diode Forward Voltage (Note 1)	$V_{\text{SD}}$	$I_S=18\text{A}, V_{\text{GS}}=0\text{V}$			1.4	V
Reverse Recovery Time (Note 1)	$t_{\text{rr}}$	$I_S=18\text{A}, V_{\text{GS}}=0\text{V}$ $dI/dt=100\text{A}/\mu\text{s}$		172		ns
Reverse Recovery Charge	$Q_{\text{rr}}$			1.1		$\mu\text{C}$

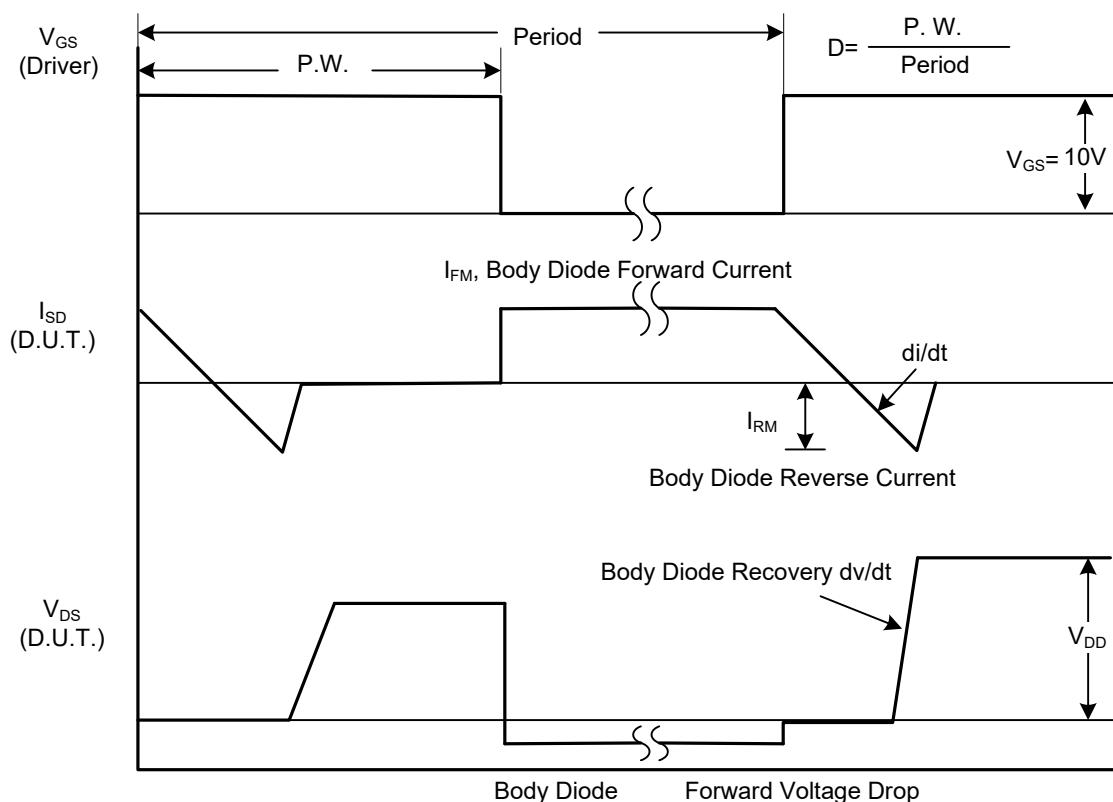
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating temperature.

### ■ TEST CIRCUITS AND WAVEFORMS

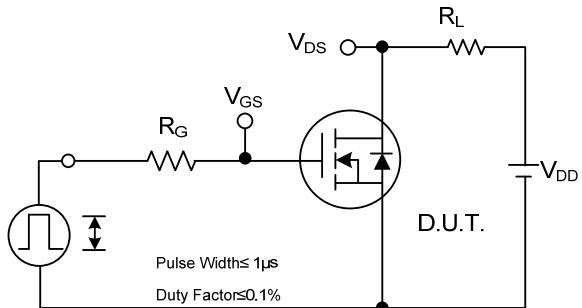


Peak Diode Recovery dv/dt Test Circuit

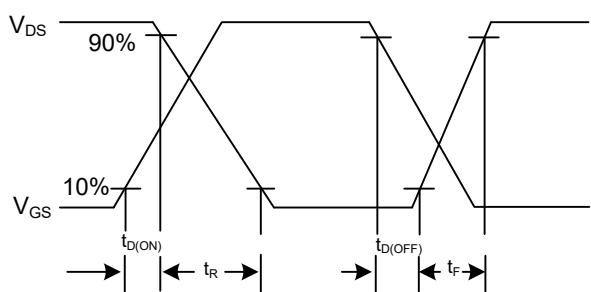


Peak Diode Recovery dv/dt Waveforms

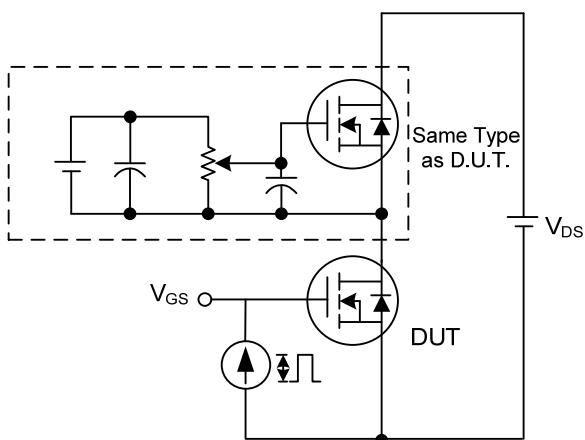
### ■ TEST CIRCUITS AND WAVEFORMS



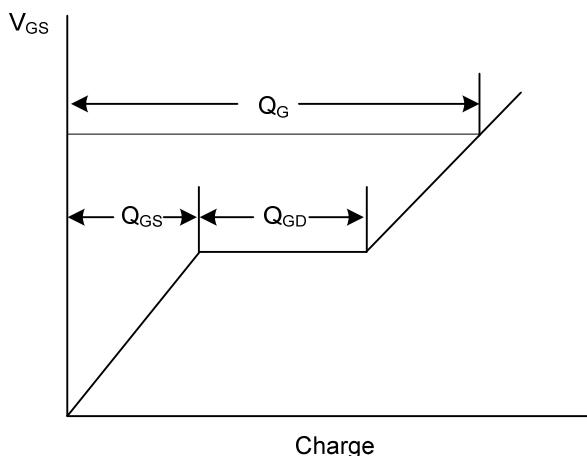
**Switching Test Circuit**



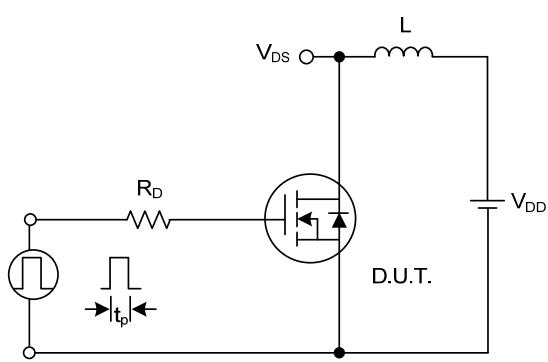
**Switching Waveforms**



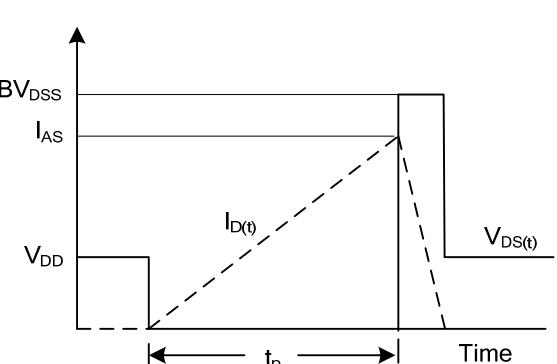
**Gate Charge Test Circuit**



**Gate Charge Waveform**

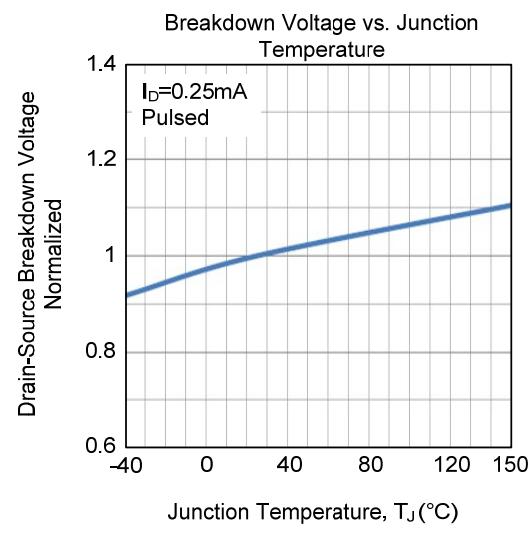
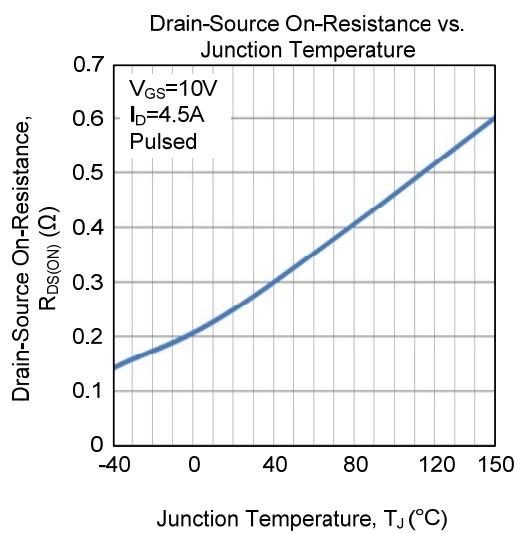
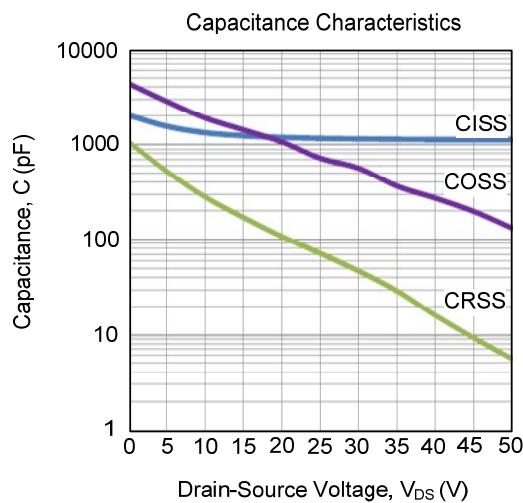
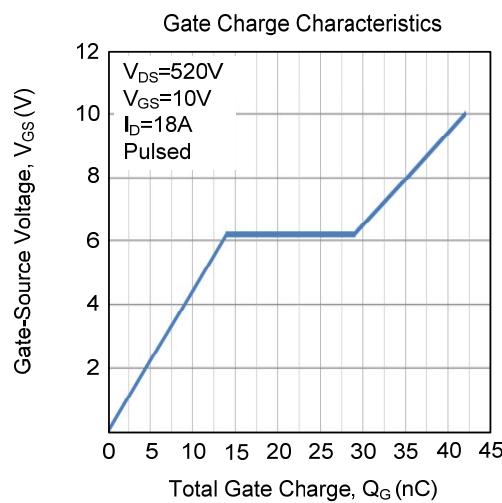
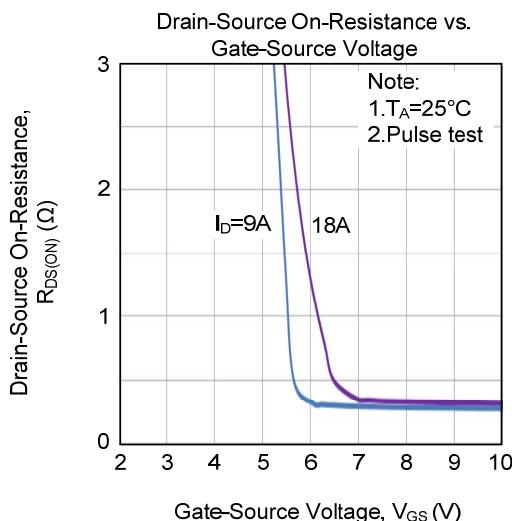
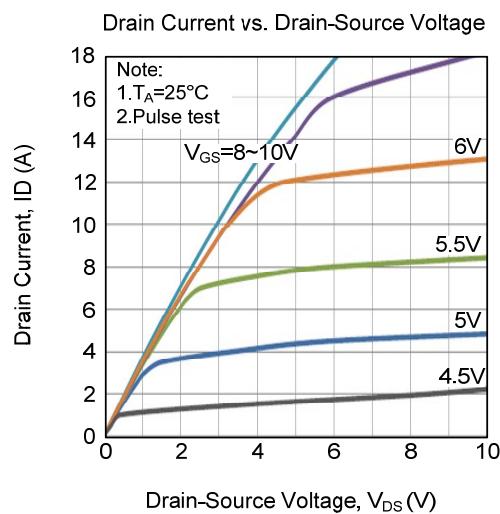


**Unclamped Inductive Switching Test Circuit**

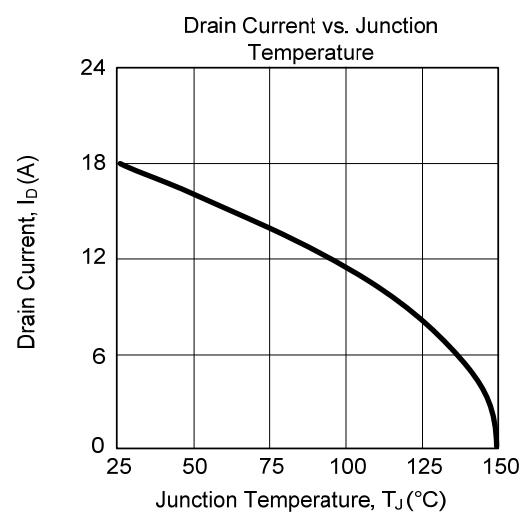
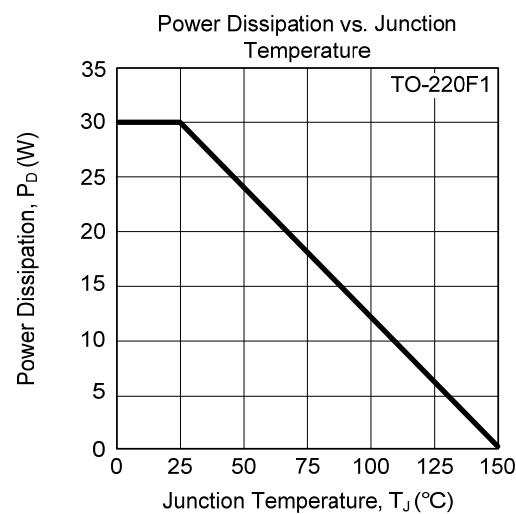
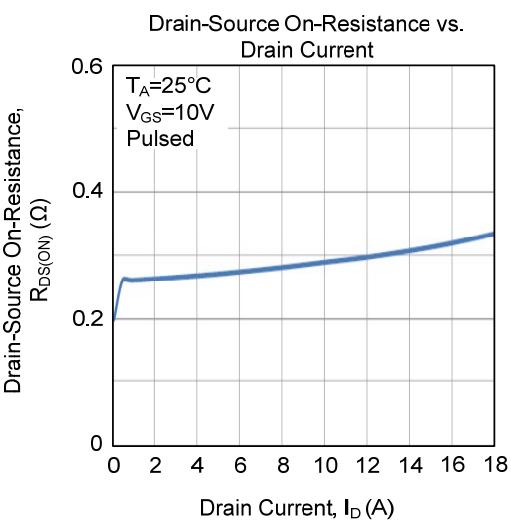
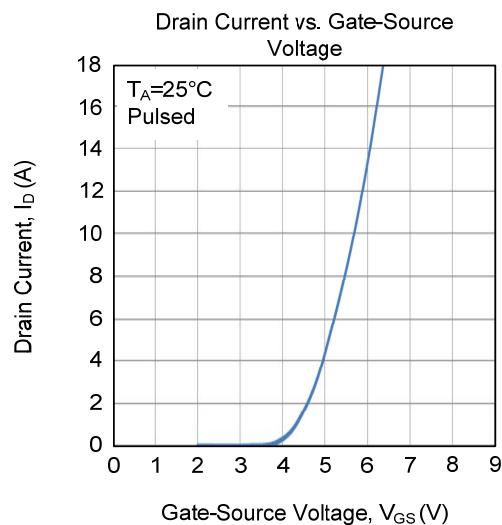
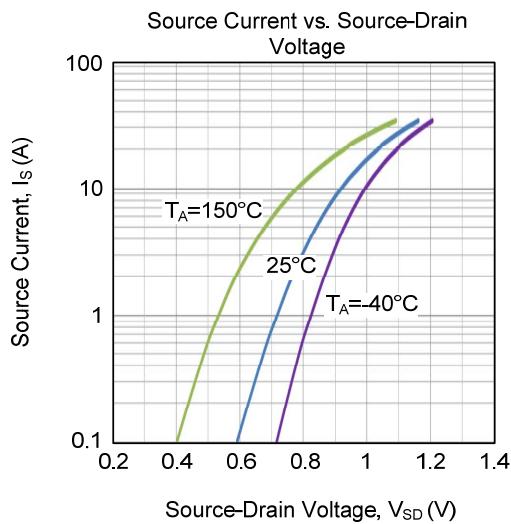
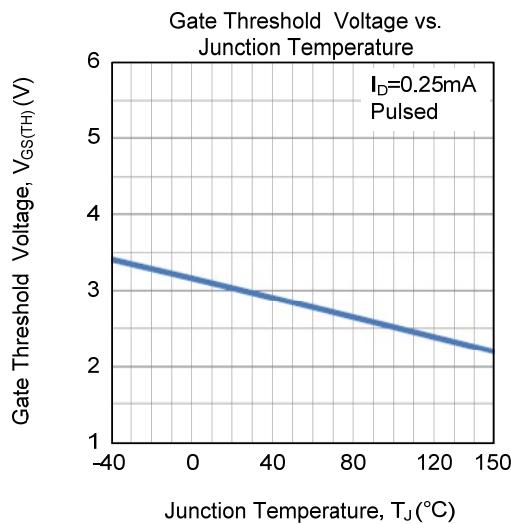


**Unclamped Inductive Switching Waveforms**

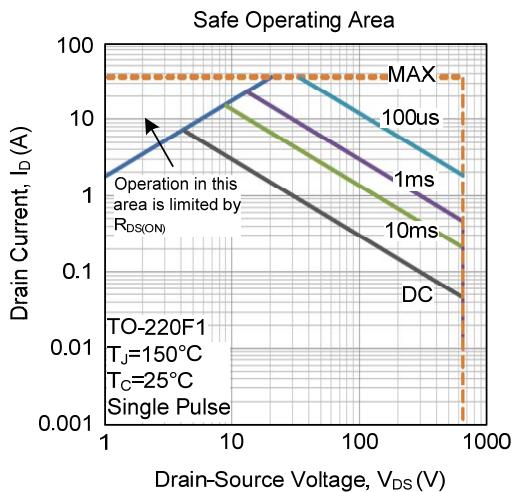
### ■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



- TYPICAL CHARACTERISTICS (Cont.)



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